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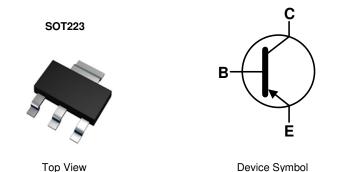
400V PNP HIGH VOLTAGE TRANSISTOR IN SOT223

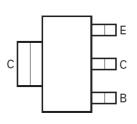
Features

- BV_{CEO} > -400V
- I_C = -200mA High Continuous Current
- Excellent hFE Characteristics up to -100mA
- Low Saturation Voltage V_{CE(sat)} < -200mV @ -20mA
- Complementary NPN Type: FZT458
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic. "Green" Molding Compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads.
 Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.112 grams (Approximate)





Top View Pin-Out

Ordering Information (Note 4)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FZT558TA	AEC-Q101	FZT558	7	12	1.000

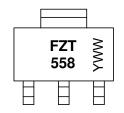
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information

Notes:

SOT223



FZT 558 = Product Type Marking Code YWW = Date Code Marking Y or \overline{Y} = Last Digit of Year (ex: 5= 2015) WW or $\overline{W}W$ = Week Code (01~53)





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-400	V
Collector-Emitter Voltage	V _{CEO}	-400	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	Ic	-200	mA

Thermal Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 5)	В	2	W
Power dissipation	(Note 6)	P _D	3	W
Thermal Desistance, Junction to Ambient	(Note 5)	7	62.5	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{\theta JA}$	41.7	°C/W
Thermal Resistance, Junction to Leads (Note 7	$R_{ heta JL}$	19.41	°C/W	
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-55 to +150	°C	

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted with the collector lead on 25mm x 25mm 2oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

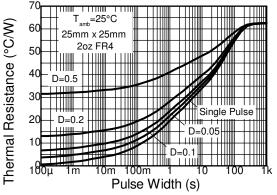
6. Same as note (5), except the device is mounted on 50mm x 50mm single sided 2oz weight copper.

7. Thermal resistance from junction to solder-point (at the end of the collector lead).

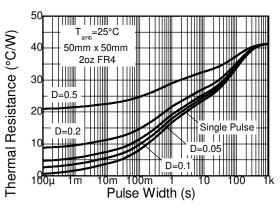
8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



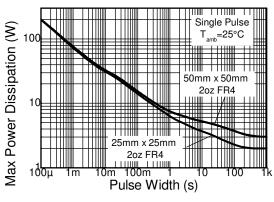
Thermal Characteristics and Derating Information



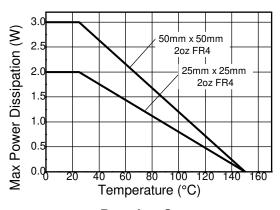
Transient Thermal Impedance



Transient Thermal Impedance



Pulse Power Dissipation



Derating Curve





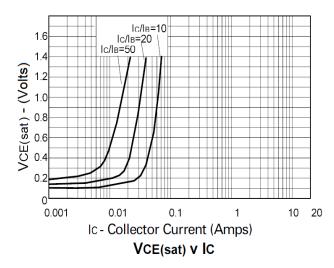
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

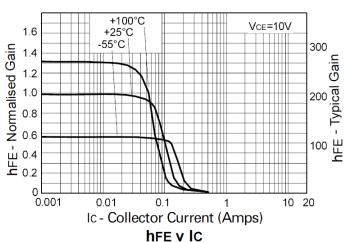
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-400	_	_	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-400	_	_	V	$I_C = -1mA$
Emitter-Base Breakdown Voltage	BV_{EBO}	-7	-	-	V	$I_E = -100 \mu A$
Collector Cut-Off Current	I _{CBO}	_	_	-100	nA	$V_{CB} = -320V$
Collector Cut-Off Current	I _{CES}	-	_	-100	nA	V _{CES} = -320V
Emitter Cut-Off Current	I _{EBO}	-	_	-100	nA	$V_{EB} = -5V$
Collector Emitter Saturation Voltage (Note 0)	V _{CE(sat)}	-	_	-0.2	V	$I_C = -20 \text{mA}, I_B = -2 \text{mA}$
Collector-Emitter Saturation Voltage (Note 9)		_	_	-0.5	V	$I_C = -50 \text{mA}, I_B = -6 \text{mA}$
Base-Emitter Saturation Voltage (Note 9)	V _{BE(sat)}	_	-	-0.9	V	$I_C = -50 \text{mA}, I_B = -5 \text{mA}$
Base-Emitter Turn-On Voltage (Note 9)	$V_{BE(on)}$	_	-	-0.9	V	$I_C = -50 \text{mA}, V_{CE} = -10 \text{V}$
DC Current Transfer Static Ratio (Note 9)	h _{FE}	100 100 15	- - -	300	-	$I_C = -1mA$, $V_{CE} = -10V$ $I_C = -50mA$, $V_{CE} = -10V$ $I_C = -100mA$, $V_{CE} = -10V$
Transitional Frequency (Note 9)	f _T	50	-	-	MHz	V _{CE} = -20V, I _C = -10mA f = 20MHz
Output Capacitance (Note 9)	C_{obo}	-	-	5	pF	V _{CB} = -20V. f = 1MHz
Switching Times	t _{on} t _{off}	_	95 1,600	_	ns	$I_C = -50 \text{mA}, V_C = -100 \text{V}$ $I_{B1} = 5 \text{mA}, I_{B2} = -10 \text{mA}$

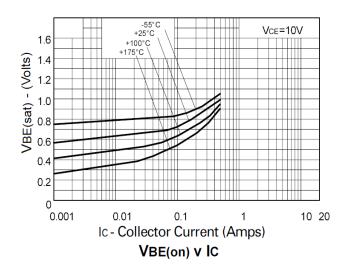
Note: 9. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

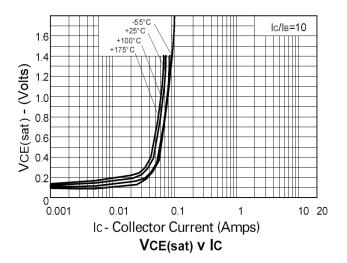


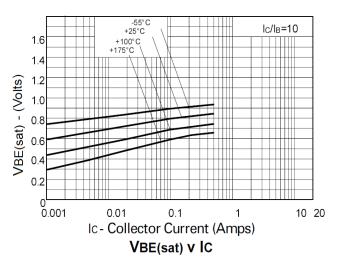
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)









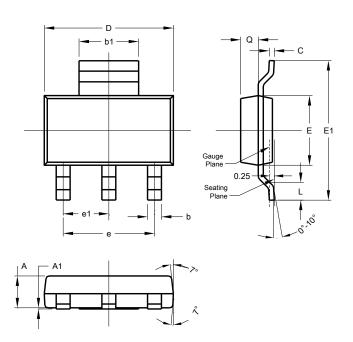




Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

SOT223

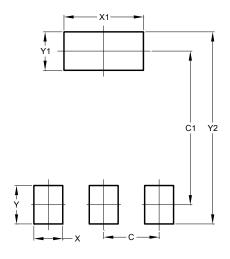


SOT223					
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
E	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	_	_	4.60		
e1	_		2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

SOT223



Dimensions	Value (in mm)
С	2.30
C1	6.40
Х	1.20
X1	3.30
Υ	1.60
Y1	1.60
Y2	8.00

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking.





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